Welcome to O-leading

We are professional PCB manufacturer with more than ten years experiences . Products range-single, double side ,multi-layer PCB ,flexible PCB and MCPCB.We can provide fast prototype service – S/S in 24hrs , 4-8layers in 48-96 working hrs production time. (Thick copper pcb Manufacturer)

COPPER PLATE HOLES MINIMUM .025 AVG, .020 MIN.. HOLES MAY NOT BE PLUGGED

Pack with colorless transparent bubble film ,25 PCS/ bag, put desiccant in flank, put humidity indicator card on top side $\frac{1}{2}$

PLEASE CLICK THESE FOR MORE INFORMATION: Thick copper pcb wholesales china

Product Description

| PCB P/N | heavy copper pcb with 3/3oz |
|----------------------------------|--|
| Layer Count | 2L |
| Material | FR-4 TG130 |
| Board thk | 1.00mm |
| copper thk | 3/3oz |
| Smallest hole size | 0.50mm |
| No. of holes (pcs) | 106 |
| line w/s | 10/10mil |
| Impedance control. Y / N (Tol %) | N |
| Surface Finishing | LF-HASL |
| Solder Mask Silkscreen | Green/ N/A |
| Single board size | Dim X (mm): 44.5; Dim Y (mm): 34 |
| Panelisation | Dim X (mm):198;Dim Y (mm):156;No Of UPS:16 |
| Special:peelable mask | N |
| Routing/Punching | CNC |

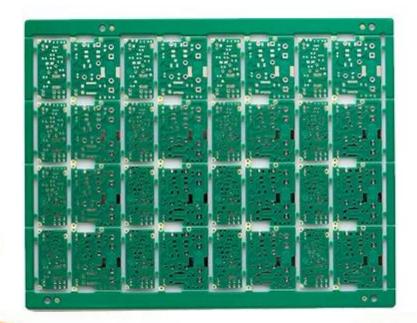












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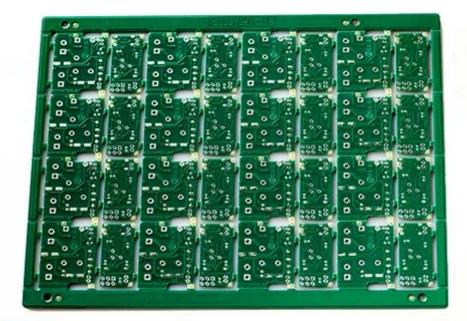












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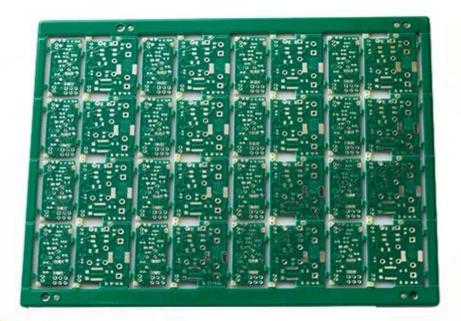






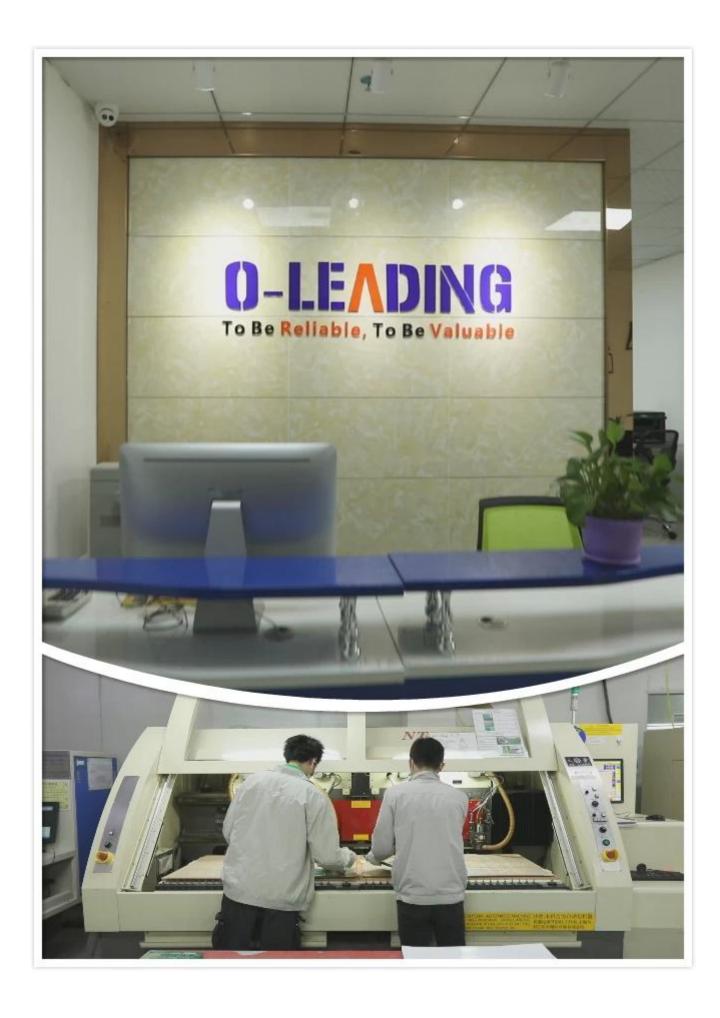






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Our Team





Certifications





QUALITY MANAGEMENT SYSTEM CERTIFICATE

We hereby certify that O-LEADING SUPPLY CHAIN(HK) CO., LIMITED Credit No: 61691591-000-07-17-2

Registration Add ROOM 600D BF HANG PONT COMMERCIAL BULLDING,31 TOMKIN ST CHEUND SHAW WANKL HK Business Add:1312 Floor 12 Fortune Building, Dansbul Town, Hulyang District, Hulchos, Guangdong, China

Has implemented and maintains a Quality Management System

Which fulfils the requirements of the following standards

GB/T19001-2016 ldt ISO9001:2015

Scope of certification

Sales of printed circuit boards

Initial Issuance period: February 27, 2018 This certificate is valid during: February 27, 2018 — February 26, 2021 This certificate is invalid without CICC qualified label in the following period

| First | Qualified | Г |
|-------------|-----------|-----|
| supervision | 1000 | 1.0 |
| and audit | man | |

Second Gualfied supervision mark and audit

CICC TAB CNAS

2017/26

ZPWVZE40054 - Winny, Printed - Component



ZPMV2.E490354 Wiring, Printed - Component

For enhanced search functionality, please visit 0.1×10^{-6} Family of Databases. Citix on a product designation for complete information.

Wiring, Printed - Component

See General Information for Wiring, Printed - Component

Q-LEADING SUPPLY CHAIN CO LIMITED

E490354

Fortune Building, Nanhang West Road Room 1313 Huithou, Guangdong 51621; CHINA

| 1 | Cond | Width | | | Max | - 2 | | Max | | 3 | |
|--------|-----------------|-----------------|----------------------|-------|------------|-----|------|------|-------|----------|----|
| | | Min | Cond | SS/ | Aren | Sol | der | Oper | | Nests | G |
| | Min | Edge | This | D5/ | Diam | Lin | ette | Tump | Flame | UL796 | 7 |
| Турс | mm(in) | mm(in) | mic(mil) | 090 | mer(in) | c | sec | c | Class | DSR | 1 |
| Hulti | ayer (mass lan | ninate) printed | wiring boa | erds, | | | | | | (i -) | |
| O-LE | ADING-401 | | | | | | | | | | Т |
| 1 13 | 0.1 (0.004) | 0.3 (0.012) | 34 (1.34) | DE | 12.7 (0.5) | 260 | 10 | 130 | V-0 | | 1 |
| 0-15 | ADING-407 | 100.000.000 | | | | | | | | | |
| | 0.08 (0.003) | 0.2 (0.008) | 17 (0-67) | DS | 9.7 (0.4) | 260 | 10 | 130 | V-0 | All . | ŀ |
| Hulti | ayer printed w | iring boards. | | | | | | | | | _ |
| D-LE | ADING-408 | | | | | | | | 00 | -0. 0 | N |
| | 0.125 (0.005) | 0.125 (0.005) | 12 (0.47) Int:136 | DS | 50.8 (2.0) | 280 | 20 | 130 | V+0 | All | |
| Single | e layer printed | wiring boards. | | | | | | | | | |
| O-LE | DING-002 | 10 | | rs. 6 | 53 113 | | | | | 3 0 | |
| | 0.78 (0.015) | 1.14 (0.045) | 34 (1,34) | 55 | (9.1 (0.0) | 260 | 10 | 105 | V-0 | M | ŀ |
| 0-12 | ADING-003 | | | | 3 | | | | | | i, |
| | 0.38 (0.015) | 1.14 (0.045) | 34 (1.34) | 55 | 19.1 (0.8) | 260 | 10 | 130 | 940 | A | ŀ |
| 0-LE | ADING-033 | | 1 | | 3 8 | | | | | | 1 |
| | 0.15 (0.006) | 0.3 (0.012) | 34 (1.34) | 55 | 25.9 (1.0) | 260 | 10 | 120 | 940 | 41 | - |
| O-LE | ADING-205 | | 3 | | | | | | | | |
| | 0.1 [0.004] | 0.5 (0.012) | 34 (1.34) | 06 | 69.6 (2.7) | 250 | 10 | 130 | V+0 | All . | - |
| | | | | | | | | | | | |
| 0-15 | DING-206 | | | | | | | | | | |

* - CTI marking is optional and may be marked on the printed wiring board.

Nording: Company name or file number and type designation. Nay be followed by a suffix to decote factory identification to burning text describation. Last ligitated in 2017-91-97.

Questions? Print this gage Terms of Use rapidatase Journa (BAYVInglandSEKT/ERVINELLogoga) milkare ZEMVZ, Edition Landaudi Villing (Printe) +Corporation (- 12

SGS

Test Report

No. CANEC1805164701

Date: 03 Apr 2018 Page 2 of 6

Test Results :

Test Part Description :

scimen No. SGS Sample ID Description SN1 CAN18-051647.001 Green "PCB"

(1) 1 mg/kg = 1 ppm = 0.0001% (2) MDL = Method Detection Limit (3) ND = Not Detected (< MDL) (4) "-" = Not Regulated

RoHS Directive (EU) 2015/863 amending Annex II to Directive 2011/65/EU

Test Method: With reference to IEC 62321-4:2013+A1:2017, IEC62321-5:2013, IEC62321-7:22017, IEC 62321-6:2015 and IEC62321-6:2017, analyzed by ICP-OES, UV-Vis and GC-MS.

| Test Rem(s) | Limit | Unit | MOL | 001 |
|----------------------------|-------|---------|-----|------|
| Cadmium (Cd) | 100 | mg/kg | 2 | NO |
| Lead (Pb) | 1.000 | mg/kg | 2 | 9 |
| Mercury (Hg) | 1.000 | mg/kg | 2 | ND |
| Hexavalent Chromium (CrVI) | 1.000 | mg/kg | 8 | NO |
| Sum of PBBs | 1,000 | mg/kg | 12 | NO |
| Monobromobiphenyl | | mg/kg | 5 | NO |
| Dibromobiphenyl | | mg/kg | 5 | NO |
| Tribromobiphenyl | 4 | mg/kg | 5 | NO |
| Tetrabromobiphenyl | | mg/kg | 5 | NO |
| Pentatromobiphenyl | | mg/kg | 5 | NO |
| Haxabromobiphanyl | | mg/kg | 5 | NO |
| Heptabromobiphenyl | | mg/kg | . 5 | NO |
| Octabromobiphenyl | | mg/kg | 5 | NO |
| Nonabromobiphenyl | | mg/kg | 5 | NO |
| Decabromobiphenyl | 7700 | mg/kg | | ND |
| Sum of PBDEs | 1.000 | mg/kg | 12 | NO |
| Manabromodiphenyl ether | | mg/kg | 5 | NO |
| Dibromodiphenyl ether | - | mg/kg | 5 | NO |
| Tribromodiphenyl ether | 4 | mg/kg | 5 | NO |
| Tetrabromodiphenyl ether | | mg/kg | 5 | NO |
| Charleston and about other | | one for | | 5.67 |



Packaging & Delivery

| Packaging Details | 16 years professional OEM pcb board manufacturer(pcb board Printed company china) |
|-------------------|--|
| Delivery Detail | 7-12days |



FAQ

- 1. How do O-Leading ensure quality?
- Our high quality standard is achieved with the following.
- 1. The process is strictly controlled under ISO 9001:2008 standards.
- 2.Extensive use of software in managing the production process
- 3.State-of-art testing equipments and tools. E.g. Flying Probe, X-ray Inspection, AOI (Automated Optical Inspector) and ICT (in-circuit testing).
- 4. Dedicated quality assurance team with failure case analysis process
- 5. Continuous staff training and education
- 2. How do O-Leading keep your price competitive?

Over the last decade, prices of many raw materials (e.g. copper, chemicals) had doubled, tripled or quadrupled; Chinese currency RMB had appreciated 31% over US dollar; And our labor cost also increased significantly. However, O-Leading have kept our pricing steady. This owns entirely to our innovations in reducing cost, avoiding wastes and improving efficiency. Our prices are very competitive in the industry at the same quality level.

We believe in a win-win partnership with our customers. Our partnership will be mutually beneficial

if we can provide you an edge on cost and quality.

- 3. What kinds of boards can O-Leading process? Common FR4, high-TG and halogen-free boards, Rogers, Arlon, Telfon, aluminum/copper-based boards, PI, etc.
- 4. What data are needed for PCB production? It is best to provide data in Gerber 274-X format. In addition, Cam350, CAD, Protel 99se, PADS, DXP and Eagle can also be processed.
- 5. What's the typical process flow for multi-layer PCB? Material cutting \rightarrow Inner dry film \rightarrow inner etching \rightarrow Inner AOI \rightarrow Multi-bond \rightarrow Layer stack up Pressing \rightarrow Drilling \rightarrow PTH \rightarrow Panel Plating \rightarrow Outer Dry Film \rightarrow Pattern Plating \rightarrow Outer etching \rightarrow Outer AOI \rightarrow Solder Mask \rightarrow Component Mark \rightarrow Surface finish \rightarrow Routing \rightarrow E/T \rightarrow Visual Inspection.